

CNC7S101, CNZ3182, CNC7T101, CNC1H101 (ON3181, ON3182, ON3183, ON3184)

Optoisolators

Overview

CNC7S101 is an AC input compatible optoisolator in which two GaAs high output infrared light emitting diode chips are connected in reverse parallel as light emitting elements, and optically are connected to a high sensitivity Si phototransistor chip as a light detecting element in a small DIL 4-pin package.

This optoisolator series also includes the two-channel CNZ3182, the three-channel CNC7T101, and the four-channel CNC1H101.

The CNC7S101 series has a number of excellent features, including high I/O isolation voltage and current transfer ratio (CTR), as well as high speed response and high reliability.

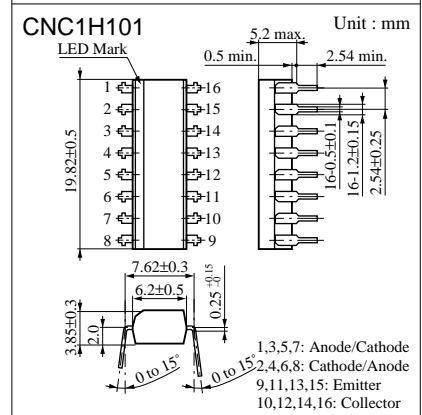
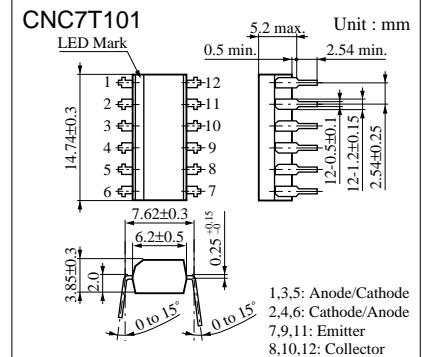
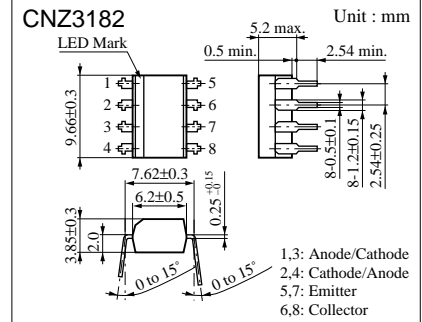
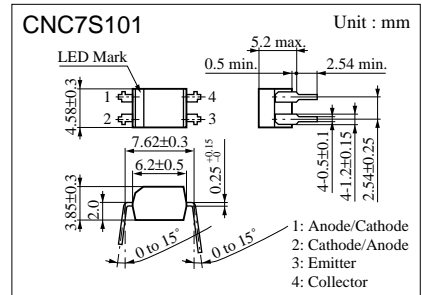
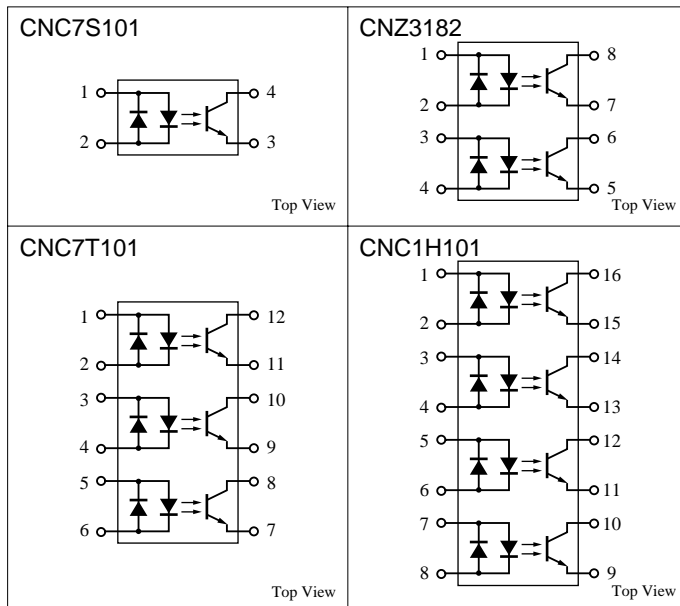
Features

- AC input support
- High I/O isolation voltage : $V_{ISO} = 5000 V_{rms}$ (min.)
- Fast response : $t_r = 4 \mu s$, $t_f = 3 \mu s$
- UL listed (UL File No. E79920)

Applications

- Telephones
- Telephone switches
- Programmable controllers
- AC/DC input modules for measuring

Pin Connection



Note) The part numbers in the parenthesis show conventional part number.

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter		Symbol	Ratings	Unit
Input (Light emitting diode)	Forward current (DC)	I _F	±50	mA
	Pulse forward current	I _{FP} ^{*1}	±1	A
	Power dissipation	P _D ^{*2}	75	mW
Output (Photo transistor)	Collector current	I _C	50	mA
	Collector to emitter voltage	V _{CEO}	80	V
	Emitter to collector voltage	V _{ECO}	7	V
Collector power dissipation		P _C ^{*3}	150	mW
Total power dissipation		P _T	200	mW
Isolation voltage, input to output		V _{ISO} ^{*4}	5000	V _{rms}
Operating ambient temperature		T _{opr}	-30 to +100	°C
Storage temperature		T _{stg}	-55 to +125	°C

*1 Pulse width ≤ 100 μs, repeat 100 pps

*2 Input power derating ratio is 0.75 mW/°C at Ta ≥ 25°C.

*3 Output power derating ratio is 1.5 mW/°C at Ta ≥ 25°C.

*4 AC 1 min, RH < 60 %

www.DataSheet4U.com

■ Electrical Characteristics (Ta = 25°C)

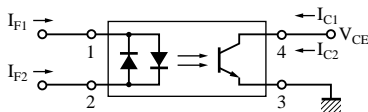
Parameter		Symbol	Conditions	min	typ	max	Unit
Input characteristics	Forward voltage (DC)	V _F	I _F = ±50mA		1.35	1.5	V
	Capacitance between pins	C _t	V _R = 0V, f = 1MHz		35		pF
Output characteristics	Collector cutoff current	I _{CEO}	V _{CE} = 20V		5	100	nA
	Collector to emitter voltage	V _{CEO}	I _C = 100μA	80			V
	Emitter to collector voltage	V _{ECO}	I _E = 10μA	7			V
	Collector to emitter capacitance	C _C	V _{CE} = 10V, f = 1MHz		3		pF
Transfer characteristics	DC current transfer ratio	CTR ^{*1,5}	V _{CE} = 5V, I _F = ±1mA	20		300	%
	Isolation capacitance, input to output	C _{ISO}	f = 1MHz		0.6		pF
	Isolation resistance, input to output	R _{ISO}	V _{ISO} = 500V	10 ¹¹			Ω
	Rise time	t _r ^{*2}	V _{CC} = 10V, I _C = 2mA,		4		μs
	Fall time	t _f ^{*3}	R _L = 100Ω		3		μs
	Collector to emitter saturation voltage	V _{CE(sat)}	I _F = ±20mA, I _C = 1mA		0.1	0.2	V
Collector current ratio	I _{C(Ratio)} ^{*4}	V _{CE} = 5V, I _F = 1mA	0.33	1.0	3.0	-	

*1 DC current transfer ratio (CTR) is a ratio of output current against DC input current

*2 t_r : Time required for the collector current to increase from 10% to 90% of its final value

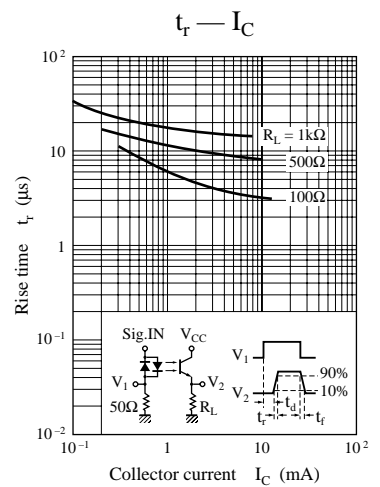
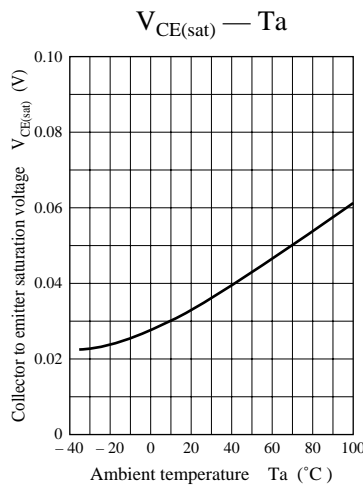
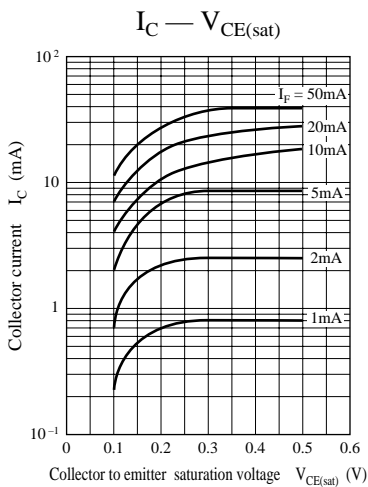
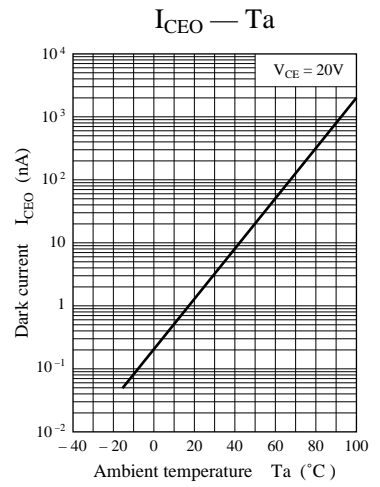
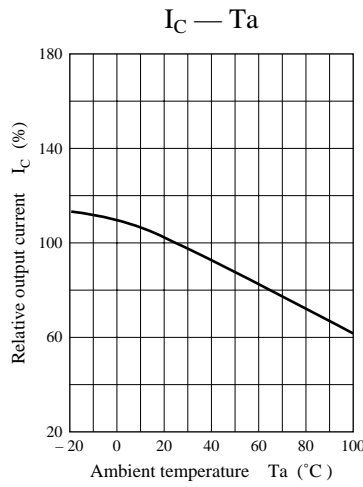
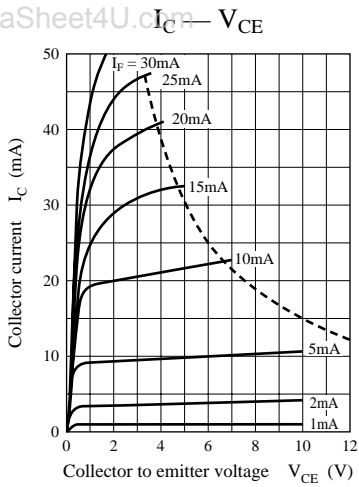
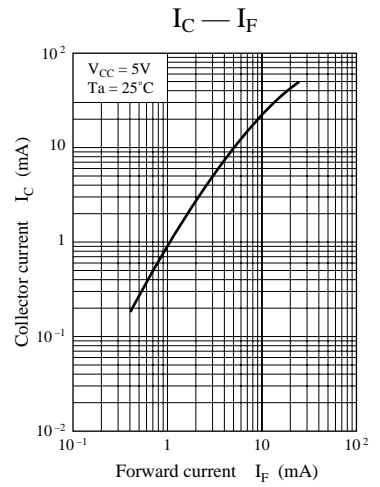
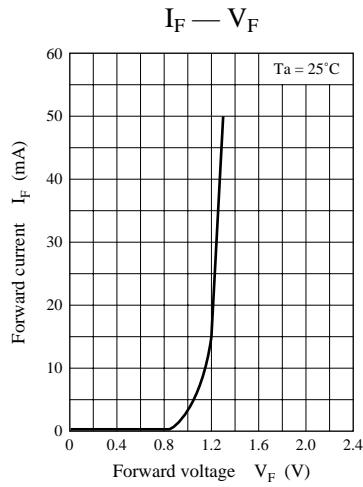
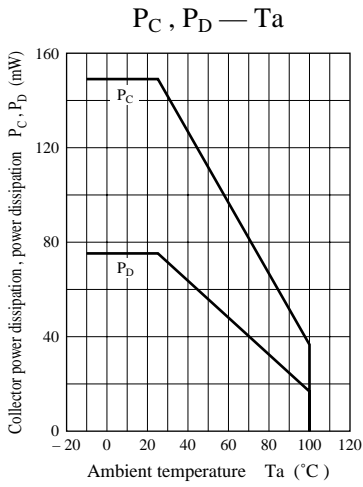
*3 t_f : Time required for the collector current to decrease from 90% to 10% of its initial value

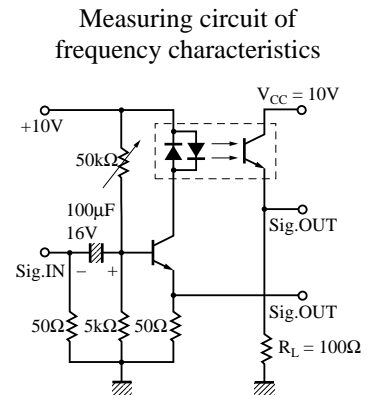
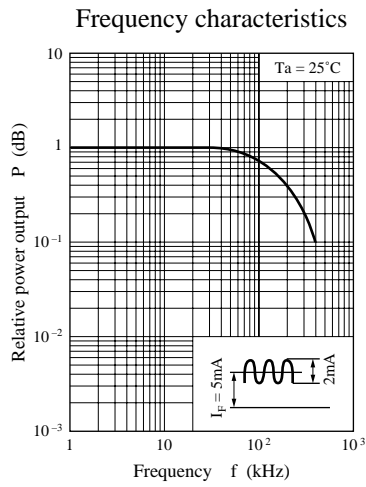
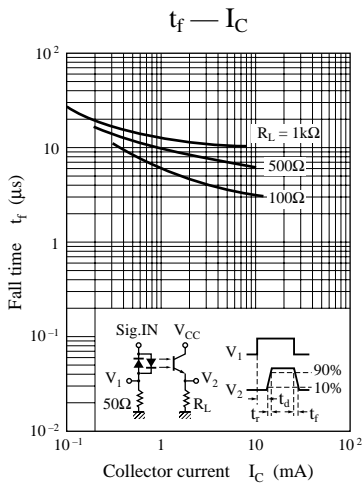
$$*4 I_{C(Ratio)} = \frac{I_{C2} (I_F=I_{F2}, V_{CE}=5V)}{I_{C1} (I_F=I_{F1}, V_{CE}=5V)}$$



*5 CTR classifications

Class	General	R	S
CTR (%)	20 to 300	50 to 150	100 to 300





Caution for Safety

 **DANGER**

Gallium arsenide material (GaAs) is used in this product.

Therefore, do not burn, destroy, cut, crush, or chemically decompose the product, since gallium arsenide material in powder or vapor form is harmful to human health.

Observe the relevant laws and regulations when disposing of the products. Do not mix them with ordinary industrial waste or household refuse when disposing of GaAs-containing products.

Request for your special attention and precautions in using the technical information and semiconductors described in this material

- (1) An export permit needs to be obtained from the competent authorities of the Japanese Government if any of the products or technologies described in this material and controlled under the "Foreign Exchange and Foreign Trade Law" is to be exported or taken out of Japan.
- (2) The technical information described in this material is limited to showing representative characteristics and applied circuit examples of the products. It does not constitute the warranting of industrial property, the granting of relative rights, or the granting of any license.
- (3) The products described in this material are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).
Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
- (4) The products and product specifications described in this material are subject to change without notice for reasons of modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the guaranteed values, in particular those of maximum rating, the range of operating power supply voltage and heat radiation characteristics. Otherwise, we will not be liable for any defect which may arise later in your equipment.
Even when the products are used within the guaranteed values, redundant design is recommended, so that such equipment may not violate relevant laws or regulations because of the function of our products.
- (6) When using products for which dry packing is required, observe the conditions (including shelf life and after-unpacking standby time) agreed upon when specification sheets are individually exchanged.
- (7) No part of this material may be reprinted or reproduced by any means without written permission from our company.

Please read the following notes before using the datasheets

- A. These materials are intended as a reference to assist customers with the selection of Panasonic semiconductor products best suited to their applications.
Due to modification or other reasons, any information contained in this material, such as available product types, technical data, and so on, is subject to change without notice.
Customers are advised to contact our semiconductor sales office and obtain the latest information before starting precise technical research and/or purchasing activities.
- B. Panasonic is endeavoring to continually improve the quality and reliability of these materials but there is always the possibility that further rectifications will be required in the future. Therefore, Panasonic will not assume any liability for any damages arising from any errors etc. that may appear in this material.
- C. These materials are solely intended for a customer's individual use.
Therefore, without the prior written approval of Panasonic, any other use such as reproducing, selling, or distributing this material to a third party, via the Internet or in any other way, is prohibited.